



AiP74LVC3G34

Triple Buffer

Product Specification

Specification Revision History:

Version	Date	Description
2017-04-A1	2017-04	New
2021-12-A2	2021-12	Modify ordering information
2022-02-A3	2022-02	Modify ambient temperature to -40°C~+105°C and add electrical characteristics of -40°C~+105°C
2022-03-A4	2022-03	Modify ordering information note 1



1、General Description

The AiP74LVC3G34 provides three buffers.

The inputs can be driven from either 3.3V or 5V devices. This feature allows the use of the AiP74LVC3G34 as a translator in a mixed 3.3V and 5V environment.

This device is fully specified for partial power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing a damaging backflow current through the device when it is powered down.

Features:

- Wide supply voltage range from 1.65V to 5.5V
- 5V tolerant input/output for interfacing with 5V logic
- $\pm 24\text{mA}$ output drive ($V_{CC}=3.0\text{V}$)
- CMOS low power consumption
- Direct interface with TTL levels
- Specified from -40°C to $+105^\circ\text{C}$
- Packaging information:TSSOP8/VSSOP8

Ordering Information:

Reel packing specifications:

Part number	Packaging form	Marking code	Reel quantity	Boxed reel quantity	Notes
AiP74LVC3G34TA8.TR	TSSOP8	DCXX	3000 PCS/reel	6000 PCS/box	Dimensions of plastic enclosure: $3.0\text{mm} \times 3.0\text{mm}$ Pin spacing:0.65mm
AiP74LVC3G34YA8.TR	VSSOP8	DCXX	3000 PCS/reel	3000 PCS/box	Dimensions of plastic enclosure: $2.0\text{mm} \times 2.3\text{mm}$ Pin spacing:0.50mm

Note 1: "XX" refers to variable content, meaning year and package batch serial number.

Note 2: If the physical information is inconsistent with the ordering information, please refer to the actual product.



2、Block Diagram And Pin Description

2.1、Block Diagram

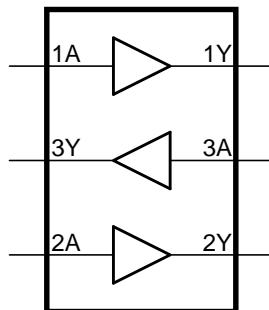


Figure 1. Logic symbol

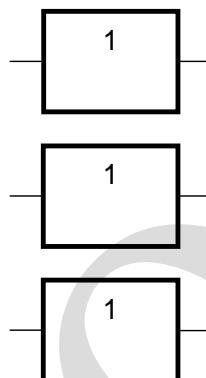
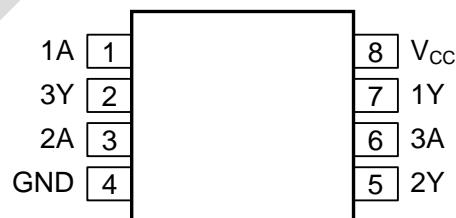


Figure 2. IEC logic symbol



Figure 3. Logic diagram (one gate)

2.2、Pin Configurations





Wuxi I-CORE Electronics Co., Ltd.

Tab: 835-12

rev:B3

Number: AiP74LVC3G34-AX-LJ-B086EN

2.3、Pin Description

Pin No.	Pin Name	Description
1	1A	data input
2	3Y	data output
3	2A	data input
4	GND	ground (0V)
5	2Y	data output
6	3A	data input
7	1Y	data output
8	V _{CC}	supply voltage

2.4、Function Table

Input	Output
nA	nY
L	L
H	H

Note: H=HIGH voltage level; L=LOW voltage level

3、Electrical Parameter

3.1、Absolute Maximum Ratings

(T_{amb}=25°C, All voltage referenced to GND, unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	V _{CC}	-	-0.5	+6.5	V
input clamping current	I _{IK}	V _I <0V	-50	-	mA
input voltage	V _I	- ^[1]	-0.5	+6.5	V
output clamping current	I _{OK}	V _O >V _{CC} or V _O <0V	-	±50	mA
output voltage	V _O	Active mode ^[1]	-0.5	V _{CC} +0.5	V
		Power-down mode ^[1]	-0.5	+6.5	V
output current	I _O	V _O =0V to V _{CC}	-	±50	mA
supply current	I _{CC}	-	-	100	mA
ground current	I _{GND}	-	-100	-	mA
storage temperature	T _{stg}	-	-65	+150	°C
total power dissipation	P _{tot}	- ^[2]	-	250	mW
soldering temperature	T _L	10s	250	-	°C

Note:

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP8 package: above 55°C the value of P_{tot} derates linearly with 2.5mW/K.

For VSSOP8 package: above 110°C the value of P_{tot} derates linearly with 8mW/K.



3.2、Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	V _{CC}	-	1.65	-	5.5	V
input voltage	V _I	-	0	-	5.5	V
output voltage	V _O	Active mode	0	-	V _{CC}	V
		Power-down mode; V _{CC} =0V	0	-	5.5	V
ambient temperature	T _{amb}	-	-40	-	+105	°C
input transition rise and fall rate	Δt/ΔV	V _{CC} =1.65V to 2.7V	-	-	20	ns/V
		V _{CC} =2.7V to 5.5V	-	-	10	ns/V

3.3、Electrical Characteristics

3.3.1、DC Characteristics 1

(T_{amb}=-40°C to +85°C, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ. ^[1]	Max.	Unit	
HIGH-level input voltage	V _{IH}	V _{CC} =1.65V to 1.95V	0.65 × V _{CC}	-	-	V	
		V _{CC} =2.3V to 2.7V	1.7	-	-	V	
		V _{CC} =2.7V to 3.6V	2.0	-	-	V	
		V _{CC} =4.5V to 5.5V	0.7 × V _{CC}	-	-	V	
LOW-level input voltage	V _{IL}	V _{CC} =1.65V to 1.95V	-	-	0.35 × V _{CC}	V	
		V _{CC} =2.3V to 2.7V	-	-	0.7	V	
		V _{CC} =2.7V to 3.6V	-	-	0.8	V	
		V _{CC} =4.5V to 5.5V	-	-	0.3 × V _{CC}	V	
HIGH-level output voltage	V _{OH}	V _I =V _{IH} or V _{IL}	I _O =-100uA; V _{CC} =1.65V to 5.5V	V _{CC} - 0.1	-	-	V
			I _O =-4mA; V _{CC} =1.65V	1.2	-	-	V
			I _O =-8mA; V _{CC} =2.3V	1.9	-	-	V
			I _O =-12mA; V _{CC} =2.7V	2.2	-	-	V
			I _O =-24mA; V _{CC} =3.0V	2.3	-	-	V
			I _O =-32mA; V _{CC} =4.5V	3.8	-	-	V
LOW-level output voltage	V _{OL}	V _I =V _{IH} or V _{IL}	I _O =100uA; V _{CC} =1.65V to 5.5V	-	-	0.10	V
			I _O =4mA; V _{CC} =1.65V	-	-	0.45	V
			I _O =8mA; V _{CC} =2.3V	-	-	0.30	V
			I _O =12mA; V _{CC} =2.7V	-	-	0.40	V
			I _O =24mA; V _{CC} =3.0V	-	-	0.55	V
			I _O =32mA; V _{CC} =4.5V	-	-	0.55	V
input leakage current	I _I	V _I =5.5V or GND; V _{CC} =0V to 5.5V	-	±0.1	±1	uA	
power-off leakage current	I _{OFF}	V _I or V _O =5.5V; V _{CC} =0V	-	±0.1	±2	uA	



supply current	I_{CC}	$V_I=5.5V$ or GND; $I_O=0A$; $V_{CC}=1.65V$ to 5.5V	-	0.1	4	uA
additional supply current	ΔI_{CC}	per pin; $V_I=V_{CC}-0.6V$; $I_O=0A$; $V_{CC}=2.3V$ to 5.5V	-	5	500	uA
input capacitance	C_I	$V_{CC}=3.3V$; $V_I=GND$ to V_{CC}	-	2.5	-	pF

Note: All typical values are measured at $V_{CC}=3.3V$ and $T_{amb}=25^\circ C$.

3.3.2、DC Characteristics 2

($T_{amb}=-40^\circ C$ to $+105^\circ C$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ. ^[1]	Max.	Unit	
HIGH-level input voltage	V_{IH}	$V_{CC}=1.65V$ to 1.95V	$0.65 \times V_{CC}$	-	-	V	
		$V_{CC}=2.3V$ to 2.7V	1.7	-	-	V	
		$V_{CC}=2.7V$ to 3.6V	2.0	-	-	V	
		$V_{CC}=4.5V$ to 5.5V	$0.7 \times V_{CC}$	-	-	V	
LOW-level input voltage	V_{IL}	$V_{CC}=1.65V$ to 1.95V	-	-	$0.35 \times V_{CC}$	V	
		$V_{CC}=2.3V$ to 2.7V	-	-	0.7	V	
		$V_{CC}=2.7V$ to 3.6V	-	-	0.8	V	
		$V_{CC}=4.5V$ to 5.5V	-	-	$0.3 \times V_{CC}$	V	
HIGH-level output voltage	V_{OH}	$V_I=V_{IH}$ or V_{IL}	$I_O=-100\mu A$; $V_{CC}=1.65V$ to 5.5V	$V_{CC}-0.1$	-	V	
			$I_O=-4mA$; $V_{CC}=1.65V$	0.95	-	V	
			$I_O=-8mA$; $V_{CC}=2.3V$	1.7	-	V	
			$I_O=-12mA$; $V_{CC}=2.7V$	1.9	-	V	
			$I_O=-24mA$; $V_{CC}=3.0V$	2.0	-	V	
			$I_O=-32mA$; $V_{CC}=4.5V$	3.4	-	V	
LOW-level output voltage	V_{OL}	$V_I=V_{IH}$ or V_{IL}	$I_O=100\mu A$; $V_{CC}=1.65V$ to 5.5V	-	-	0.10	V
			$I_O=4mA$; $V_{CC}=1.65V$	-	-	0.70	V
			$I_O=8mA$; $V_{CC}=2.3V$	-	-	0.45	V
			$I_O=12mA$; $V_{CC}=2.7V$	-	-	0.60	V
			$I_O=24mA$; $V_{CC}=3.0V$	-	-	0.80	V
			$I_O=32mA$; $V_{CC}=4.5V$	-	-	0.80	V
input leakage current	I_I	$V_I=5.5V$ or GND; $V_{CC}=0V$ to 5.5V	-	-	± 1	uA	
power-off leakage current	I_{OFF}	V_I or $V_O=5.5V$; $V_{CC}=0V$	-	-	± 2	uA	
supply current	I_{CC}	$V_I=5.5V$ or GND; $I_O=0A$; $V_{CC}=1.65V$ to 5.5V	-	-	4	uA	
additional supply current	ΔI_{CC}	per pin; $V_I=V_{CC}-0.6V$; $I_O=0A$; $V_{CC}=2.3V$ to 5.5V	-	-	500	uA	



Note: All typical values are measured at $V_{CC}=3.3V$ and $T_{amb}=25^{\circ}C$.

3.3.3、AC Characteristics 1

($T_{amb}=-40^{\circ}C$ to $+85^{\circ}C$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ. ^[1]	Max.	Unit
nA to nY propagation delay	t_{pd}	see Figure 5 ^[2]	$V_{CC}=1.65V$ to $1.95V$	1.0	3.8	8.6
			$V_{CC}=2.3V$ to $2.7V$	0.5	2.4	4.4
			$V_{CC}=2.7V$	0.5	2.5	5.0
			$V_{CC}=3.0V$ to $3.6V$	0.5	2.2	4.1
			$V_{CC}=4.5V$ to $5.5V$	0.5	1.9	3.2
power dissipation capacitance	C_{PD}	$V_{CC}=3.3V$; $V_i=GND$ to V_{CC} ^[3]	-	14	-	pF

Note:

[1] Typical values are measured at $T_{amb}=25^{\circ}C$ and $V_{CC}=1.8V$, $2.5V$, $2.7V$, $3.3V$ and $5.0V$ respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in uW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i =input frequency in MHz;

f_o =output frequency in MHz;

C_L =output load capacitance in pF;

V_{CC} =supply voltage in V;

N =number of inputs switching;

$\sum(C_L \times V_{CC}^2 \times f_o)$ =sum of outputs.

3.3.4、AC Characteristics 2

($T_{amb}=-40^{\circ}C$ to $+105^{\circ}C$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ. ^[1]	Max.	Unit
nA to nY propagation delay	t_{pd}	see Figure 5 ^[2]	$V_{CC}=1.65V$ to $1.95V$	1.0	-	10.8
			$V_{CC}=2.3V$ to $2.7V$	0.5	-	5.5
			$V_{CC}=2.7V$	0.5	-	6.3
			$V_{CC}=3.0V$ to $3.6V$	0.5	-	5.1
			$V_{CC}=4.5V$ to $5.5V$	0.5	-	4.0

Note:

[1] Typical values are measured at $T_{amb}=25^{\circ}C$ and $V_{CC}=1.8V$, $2.5V$, $2.7V$, $3.3V$ and $5.0V$ respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

4、Testing Circuit

4.1、AC Testing Circuit

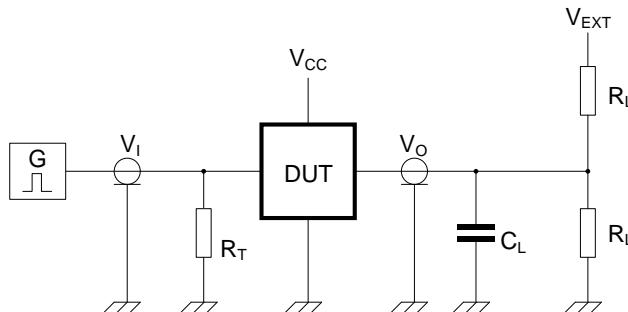


Figure 4. Test circuit for measuring switching times

Definitions for test circuit:

R_L =Load resistance.

C_L =Load capacitance including jig and probe capacitance.

R_T =Termination resistance; should be equal to the output impedance Z_o of the pulse generator.

V_{EXT} =External voltage for measuring switching times.

4.2、AC Testing Waveforms

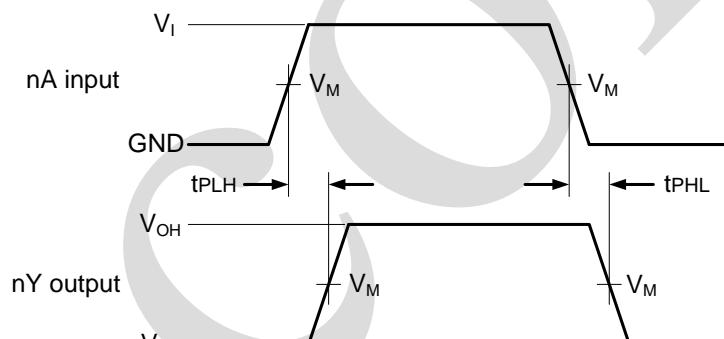


Figure 5. The input nA to output nY propagation delays



Wuxi I-CORE Electronics Co., Ltd.

Tab: 835-12

rev:B3

Number: AiP74LVC3G34-AX-LJ-B086EN

4.3、Measurement Points

Supply voltage	Input	Output
V _{CC}	V _M	V _M
1.65V to 1.95V	0.5×V _{CC}	0.5×V _{CC}
2.3V to 2.7V	0.5×V _{CC}	0.5×V _{CC}
2.7V	1.5V	1.5V
3.0V to 3.6V	1.5V	1.5V
4.5V to 5.5V	0.5×V _{CC}	0.5×V _{CC}

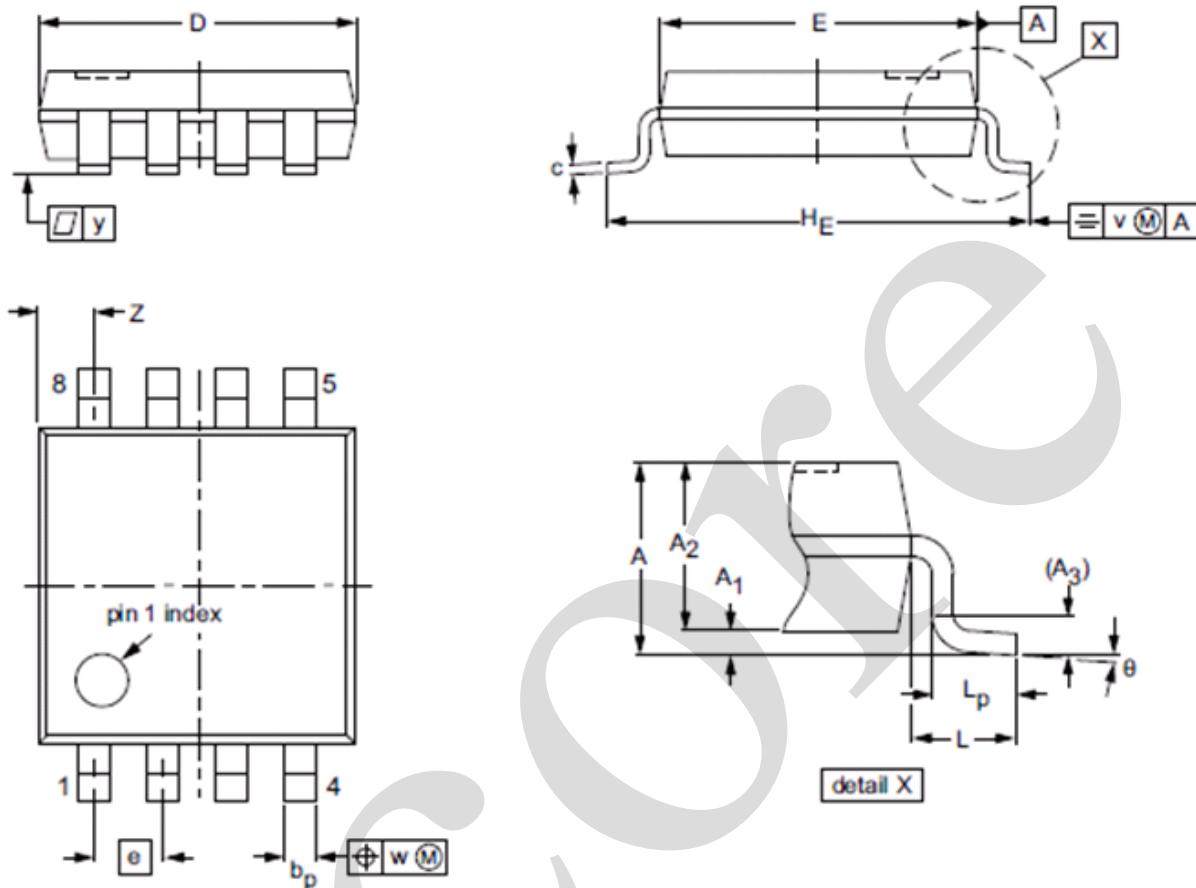
4.4、Test Data

Supply voltage	Input		Load		V _{EXT}
V _{CC}	V _I	t _{r=t_f}	C _L	R _L	t _{PLH, t_{PHL}}
1.65V to 1.95V	V _{CC}	≤2.0ns	30pF	1kΩ	open
2.3V to 2.7V	V _{CC}	≤2.0ns	30pF	500Ω	open
2.7V	2.7V	≤2.5ns	50pF	500Ω	open
3.0V to 3.6V	2.7V	≤2.5ns	50pF	500Ω	open
4.5V to 5.5V	V _{CC}	≤2.5ns	50pF	500Ω	open



5、Package Information

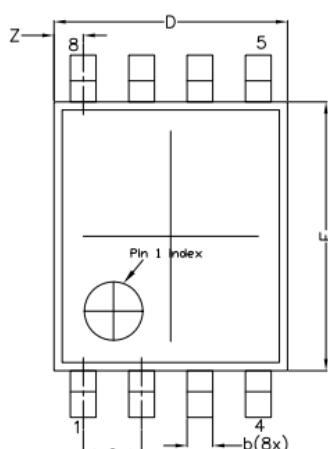
5.1、TSSOP8



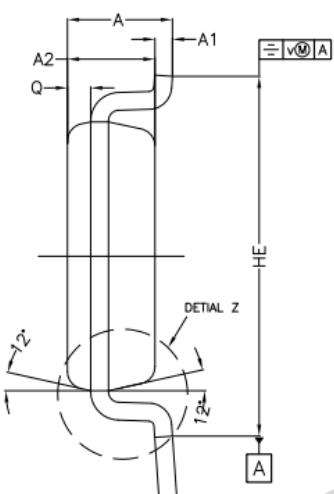
UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	v	w	y	z ⁽¹⁾	θ
mm	1.1 0.00	0.15 0.00	0.95 0.75	0.25	0.38 0.22	0.18 0.08	3.1 2.9	3.1 2.9	0.65	4.1 3.9	0.5	0.47 0.33	0.2	0.13	0.1	0.70 0.35	8° 0°



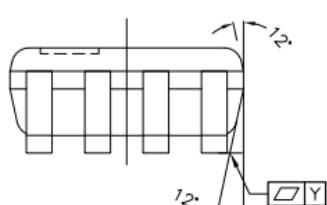
5.2、VSSOP8



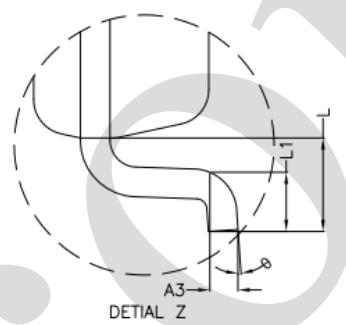
TOP VIEW



SIDE VIEW



SIDE VIEW



SYMBOL	* CONTROLLING DIMENSION : MM		
	MIN.	NOM.	MAX.
A	---	---	1.00
A1	0.00	---	0.15
A2	0.60	0.75	0.85
A3	---	0.12	---
Q	0.19	0.20	0.21
b	0.17	0.22	0.27
c	0.08	---	0.23
D	1.90	2.00	2.10
E	2.20	2.30	2.40
HE	3.00	3.10	3.20
e	0.50 bsc		
L	0.40 bsc		
L1	0.15	---	0.40
Y	---	0.10	---
v	---	0.20	---
w	---	0.08	---
Z	0.10	---	0.40
θ	0°	---	8°

NOTES

1.0 COPLANARITY APPLIES TO LEADS, CORNER LEADS AND DIE ATTACH PAD.



6、Statements And Notes

6.1、The name and content of Hazardous substances or Elements in the product

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butylbenzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	<p>○: Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard.</p> <p>×: Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements.</p>									

6.2、Notion

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